

City of Madison

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Legislation Details (With Text)

File #: 51215 Version: 1 Name: Awarding Public Works Contract No. 8093, Chip

Sealing 2018 - East.

Type: Resolution Status: Passed

File created: 4/12/2018 In control: BOARD OF PUBLIC WORKS

On agenda: 5/1/2018 **Final action:** 5/1/2018

Enactment date: 5/7/2018 Enactment #: RES-18-00337

Title: Awarding Public Works Contract No. 8093, Chip Sealing 2018 - East.

Sponsors: BOARD OF PUBLIC WORKS

Indexes:

Code sections:

Attachments: 1. Contract 8093 .pdf

Date	Ver.	Action By	Action	Result
5/1/2018	1	COMMON COUNCIL	Adopt Under Suspension of Rules 2.04, 2.05, 2.24, and 2.25	Pass
4/18/2018	1	BOARD OF PUBLIC WORKS	RECOMMEND TO COUNCIL TO ADOPT UNDER SUSPENSION OF RULES 2.04, 2.05, 2.24, & 2.25 - REPORT OF OFFICER	Pass
4/12/2018	1	Engineering Division	Refer	

Fiscal Note

The proposed resolution awards the contract for the chip sealing improvements in 2018 for aldermanic districts 15, 17, and 18. The repairs will be made at a total estimated cost of \$1.14 million. Funding is provided by the Engineering Major Streets capital program Pavement Management (MUNIS 11784); \$15.5 million is budgeted in this program for 2018. The Streets Division has budgeted \$70,000 within their supplies budget for the work they will perform to patch these streets.

Title

Awarding Public Works Contract No. 8093, Chip Sealing 2018 - East.

Body

BE IT RESOLVED, that the following low bids for miscellaneous improvements be accepted and that the Mayor and City Clerk be and are hereby authorized and directed to enter into a contract with the low bidders contained herein, subject to the Contractor's compliance with Section 39.02 of the Madison General Ordinances concerning compliance with the Affirmative Action provisions and subject to the Contractor's compliance with Section 33.07 of the Madison General Ordinances regarding Best Value Contracting:

BE IT FURTHER RESOLVED, that the funds be encumbered to cover the cost of the projects contained herein.

See attached document (Contract No. 8093) for itemization of bids.